

SCCS018 - May 1994 - Revised February 2000

CY54/74FCT245T

8-Bit Transceiver

Features

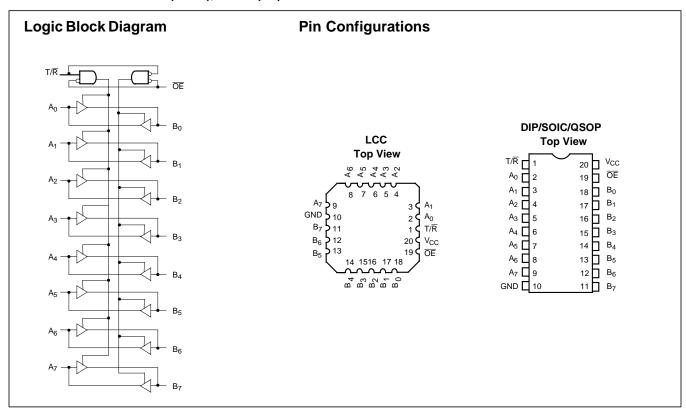
- Function, pinout, and drive compatible with FCT, and F logic
- FCT-D speed at 3.8 ns max. (Com'l), FCT-C speed at 4.1 ns max. (Com'l), FCT-A speed at 4.6 ns max. (Com'l)
- Reduced V_{OH} (typically = 3.3V) versions of equivalent FCT functions
- Edge-rate control circuitry for significantly improved noise characteristics
- · Power-off disable feature
- ESD > 2000V
- · Matched rise and fall times
- Fully compatible with TTL input and output logic levels
- Extended commercial range of -40°C to +85°C
- Sink current Source current
 64 mA (Com'l), 48 mA (Mil) 32 mA (Com'l), 12 mA (Mil)

Functional Description

The FCT245T contains eight non-inverting bidirectional buffers with three-state outputs and is intended for bus oriented applications. For the FCT245T, current sinking capability is 64 mA at the A and B ports.

The Transmit/Receiver (T/\overline{R}) input determines the direction of data flow through bidirectional transceiver. Transmit (Active HIGH) enables data from A ports to B ports. The output enable (\overline{OE}) , when HIGH, disables both the A and B ports by putting them in a High Z condition.

The outputs are designed with a power-off disable feature to allow for live insertion of boards.



Function Table^[1]

OE	T/R	Operation
L	L	B Data to Bus A
L	Н	A Data to Bus B
Н	Х	High Z State

Note:

1. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care.



Maximum Ratings^[2,3]

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied-65°C to +135°C Supply Voltage to Ground Potential.....-0.5V to +7.0V DC Input Voltage-0.5V to +7.0V

Power Dissipation	0.5W
Static Discharge Voltage	>2001V
(per MIL-STD-883, Method 3015)	

Operating Range

Range	Range	Ambient Temperature	v _{cc}
Commercial	DT	0°C to +70°C	5V ± 5%
Commercial	T, AT, CT	-40°C to +85°C	5V ± 5%
Military ^[4]	All	–55°C to +125°C	5V ± 10%

Electrical Characteristics Over the Operating Range

DC Output Voltage-0.5V to +7.0V DC Output Current (Maximum Sink Current/Pin)......120 mA

Parameter	Description	Test Condition	Min.	Typ. ^[5]	Max.	Unit	
V _{OH}	Output HIGH Voltage	V _{CC} =Min., I _{OH} =-32 mA	Com'l	2.0			V
		V _{CC} =Min., I _{OH} =–15 mA	Com'l	2.4	3.3		V
		V _{CC} =Min., I _{OH} =-12 mA	Mil	2.4	3.3		V
V _{OL}	Output LOW Voltage	V _{CC} =Min., I _{OL} =64 mA	Com'l		0.3	0.55	V
		V _{CC} =Min., I _{OL} =48mA	Mil		0.3	0.55	V
V _{IH}	Input HIGH Voltage			2.0			V
V _{IL}	Input LOW Voltage					0.8	V
V _H	Hysteresis ^[6]	All inputs			0.2		V
V _{IK}	Input Clamp Diode Voltage	V _{CC} =Min., I _{IN} =-18 mA			-0.7	-1.2	V
I _I	Input HIGH Current	V _{CC} =Max., V _{IN} =V _{CC}				5	μΑ
I _{IH}	Input HIGH Current	V _{CC} =Max., V _{IN} =2.7V				±1	μΑ
I _{IL}	Input LOW Current	V _{CC} =Max., V _{IN} =0.5V				±1	μΑ
I _{OS}	Output Short Circuit Current ^[7]	V _{CC} =Max., V _{OUT} =0.0V		-60	-120	-225	mA
I _{OFF}	Power-Off Disable	V _{CC} =0V, V _{OUT} =4.5V				±1	μΑ

Capacitance^[6]

Parameter	Description	Typ . ^[5]	Max.	Unit
C _{IN}	Input Capacitance	5	10	pF
C _{OUT}	Output Capacitance	9	12	pF

Notes:

- Unless otherwise noted, these limits are over the operating free-air temperature range. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.
- T_A is the "instant on" case temperature.
- Typical values are at V_{CC}=5.0V, T_A=+25°C ambient. This parameter is specified but not tested.
- Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I_{OS} tests should be performed last.



Power Supply Characteristics

Parameter	Description	Test Conditions	Typ. ^[5]	Max.	Unit
I _{CC}	Quiescent Power Supply Current	V _{CC} =Max., V _{IN} ≤0.2V, V _{IN} ≥V _{CC} -0.2V	0.1	0.2	mA
Δl _{CC}	Quiescent Power Supply Current (TTL inputs HIGH)	V _{CC} =Max., V _{IN} =3.4V, ^[8] f ₁ =0, Outputs Open	0.5	2.0	mA
I _{CCD}	Dynamic Power Supply Current ^[9]	V _{CC} =Max., One Input Toggling, 50% Duty Cycle, Outputs Open, T/R or OE=GND and V _{IN} ≤0.2V or V _{IN} ≥V _{CC} −0.2V	0.06	0.12	mA/MHz
I _C	Total Power Supply Current ^[10]	V _{CC} =Max., 50% Duty Cycle, Outputs Open, One Bit Toggling at f ₁ =10 MHz, T/R or OE=GND and V _{IN} ≤0.2V or V _{IN} ≥V _{CC} −0.2V	0.7	1.4	mA
		V_{CC} =Max., 50% Duty Cycle, Outputs Open, One Bit Toggling at f ₁ =10 MHz, T/ \overline{R} or \overline{OE} =GND and V_{IN} =3.4V or V_{IN} =GND	1.2	3.4	mA
		$V_{CC}=$ Max., 50% Duty Cycle, Outputs Open, Eight Bits Toggling at $f_1=2.5$ MHz, T/R or $\overline{OE}=$ GND and $V_{IN}\le 0.2V$ or $V_{IN}\ge V_{CC}-0.2V$	1.3	2.6 ^[11]	mA
		V _{CC} =Max., 50% Duty Cycle, Outputs Open, Eight Bits Toggling at f ₁ =2.5 MHz, T/R or OE=GND and V _{IN} =3.4V or V _{IN} =GND	3.3	10.6 ^[11]	mA

Notes:

All currents are in milliamps and all frequencies are in megahertz.

11. Values for these conditions are examples of the I_{CC} formula. These limits are specified but not tested.



Switching Characteristics Over the Operating Range

		FCT245T				FCT245AT					
		Military		Commercial		Military		Commercial			Fig
Parameter	Description	Min. ^[12]	Max.	Unit	Fig. No. ^[13]						
t _{PLH} t _{PHL}	Propagation Delay A to B or B to A	1.5	7.5	1.5	7.0	1.5	4.9	1.5	4.6	ns	1, 3
t _{PZH} t _{PZL}	Output Enable Time OE or T/R to A or B	1.5	10.0	1.5	9.5	1.5	6.5	1.5	6.2	ns	1, 7, 8
t _{PHZ} t _{PLZ}	Output Disable Time OE or T/R to A or B	1.5	10.0	1.5	7.5	1.5	6.0	1.5	5.0	ns	1, 7, 8

Switching Characteristics Over the Operating Range (continued)

		FCT245CT				FCT245DT				
		Military		Commercial		Commercial			Fig	
Parameter	Description	Min. ^[12]	Max.	Min. ^[12]	Max.	Min. ^[12]	Max.	Unit	Fig. No. ^[13]	
t _{PLH} t _{PHL}	Propagation Delay A to B or B to A	1.5	4.5	1.5	4.1	1.5	3.8	ns	1, 3	
t _{PZH} t _{PZL}	Output Enable Time OE or T/R to A or B	1.5	6.2	1.5	5.8	1.5	5.0	ns	1, 7, 8	
t _{PHZ}	Output Disable Time OE or T/R to A or B	1.5	5.2	1.5	4.8	1.5	4.3	ns	1, 7, 8	

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
3.8	CY74FCT245DTQCT	Q5	20-Lead (150-Mil) QSOP	Commercial
	CY74FCT245DTSOC/SOCT	S5	20-Lead (300-Mil) Molded SOIC	
4.1	CY74FCT245CTQCT	Q5	20-Lead (150-Mil) QSOP	Commercial
	CY74FCT245CTSOC/SOCT	S5	20-Lead (300-Mil) Molded SOIC	
4.5	CY54FCT245CTDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245CTLMB	L61	20-Square Leadless Chip Carrier	
4.6	CY74FCT245ATPC	P5	20-Lead (300-Mil) Molded DIP	Commercial
	CY74FCT245ATQCT	Q5	20-Lead (150-Mil) QSOP	
	CY74FCT245ATSOC/SOCT	S5	20-Lead (300-Mil) Molded SOIC	
4.9	CY54FCT245ATDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245ATLMB	L61	20-Square Leadless Chip Carrier	
7.0	CY74FCT245TQCT	Q5	20-Lead (150-Mil) QSOP	Commercial
	CY74FCT245TSOC/SOCT	S5	20-Lead (300-Mil) Molded SOIC	
7.5	CY54FCT245TDMB	D6	20-Lead (300-Mil) CerDIP	Military
	CY54FCT245TLMB	L61	20-Square Leadless Chip Carrier	

Notes:

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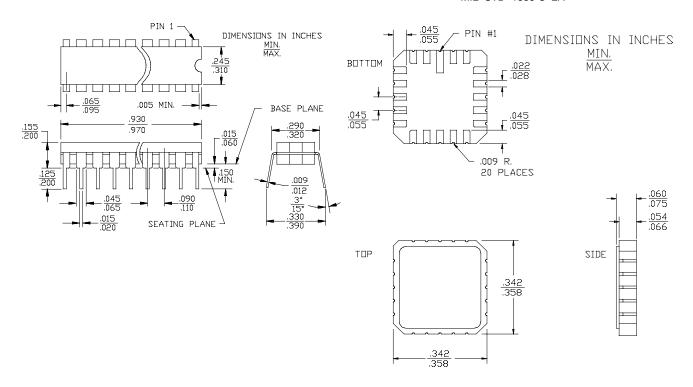
^{12.} Minimum limits are specified but not tested on Propagation Delays.13. See "Parameter Measurement Information" in the General Information section.



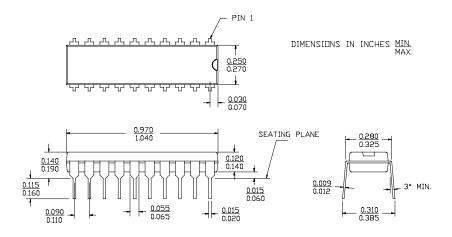
Package Diagrams

20-Lead (300-Mil) CerDIP D6 MIL-STD-1835 D-8 Config.A

20-Pin Square Leadless Chip Carrier L61 MIL-STD-1835 C-2A



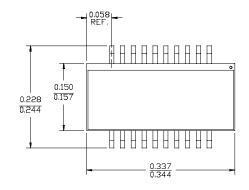
20-Lead (300-Mil) Molded DIP P5

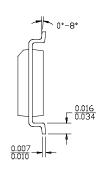


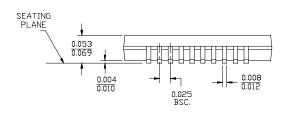


Package Diagrams (continued)

20-Lead Quarter Size Outline Q5

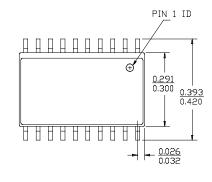




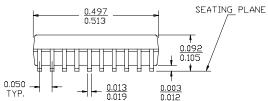


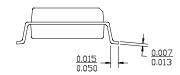
DIMENSIONS IN INCHES $\frac{\text{MIN.}}{\text{MAX.}}$ LEAD COPLANARITY 0.004 MAX.

20-Lead (300-Mil) Molded SOIC S5



DIMENSIONS IN INCHES $\frac{\text{MIN.}}{\text{MAX.}}$ LEAD COPLANARITY 0.004 MAX.





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